

Optically Immersed 2.8 μm LED in heatsink optimized housing

LED28Su, LED28Sr

TE cooled Optically Immersed 2.8 μm LED

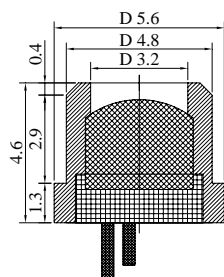
LED28TO8TEC

| | | |
|-------------------|---------------|---|
| Peak wavelength | μm | 2.83 ± 0.03 ¹ |
| Pulse power | mW | Drive current 1 A, 0.02 duty cycle $0.15 \div 0.18$ |
| Quasi-CW power | mW | Drive current 0.3 A, 0.5 duty cycle $0.05 \div 0.06$ |
| CW power | mW | Drive current 0.2 A $0.03 \div 0.04$ |
| Cut-off frequency | MHz | 20 ² |

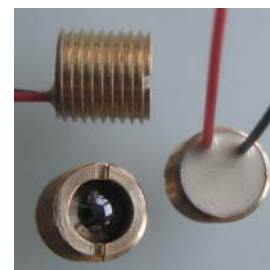
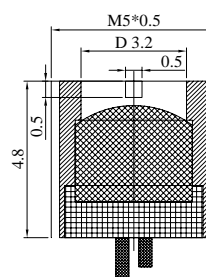
| Code | Emission size, mm | Weight, g | Optical components | Far-field pattern FWHM, deg. | Optical axis deviation, deg. | Optical power deviation in lot, % | Operation conditions, °C | Lifetime, hrs |
|--------------------|-------------------|------------|--|------------------------------|------------------------------|-----------------------------------|------------------------------|--------------------------|
| LED28Su LED28Sr | $\varnothing 3.2$ | ~ 0.4 | Si lens | ~ 15 | ≤ 5 | ± 25 | $-60 \div +120$ ³ | $> 80\,000$ ⁵ |
| LED28 TO8TEC | | ~ 10 | Si lens and output sapphire window D=6mm | | | | | |

Product view

LED28Su

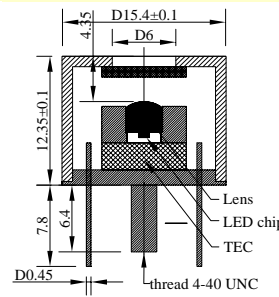
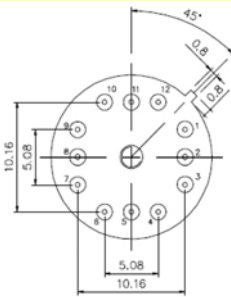


LED28Sr



Pin assignment: red wire or long wire and red point on house - positive

Pin assignment: red wire or long wire and red point on house - positive



Pin assignment
LED28TO8TEC12

1 TEC negative;
3 TEC positive;
4 LED negative;
6 LED positive;
7, 9 thermosensor;
11 \perp (House)

Features

- Original growth of narrow gap semiconductor alloys onto n^+ -InAs substrate;
- Flip-chip design of LEDs;
- Optical coupling through the use of chalcogenide glasses and Si lenses with antireflection coating
- 3-fold increased LED output power;
- Beam collimation;
- Small on-off time (tenths of ns);
- Low power consumption ($\leq 0.1\text{W}$)

Emission beam divergence is small and thus we recommend adjusting LED position regarding to the detector system before final evaluation/use of the devices. We recommend if possible using low duty cycle mode of operation with $I < 0.5 \times I_{\text{max}}$ so that higher efficiency and long term stability of a LED are achieved. Data are valid for LED attached to a heatsink and thermostabilized at 22°C. Heatsink is essential for TEC operation!

Notes

- process 296
- according to estimation
- devices have passed through 15 thermo cycles : (20°C, 8 hrs) - transition period of 30 min - (+125°C, 8 hrs) without changes in specifications. Valid for devices produced since 01.2013
- devices have passed through 15 thermo cycles : (-60°C, 30 min) - transition period of 30 min - (+85°C, 30 min) without changes in specifications. Valid for devices produced since 01.2013
- according to accelerated degradation stress at CW drive current 0.2 A

Product specifications are subject to change without prior notice due to improvements or other reasons. Updated 15.01.13

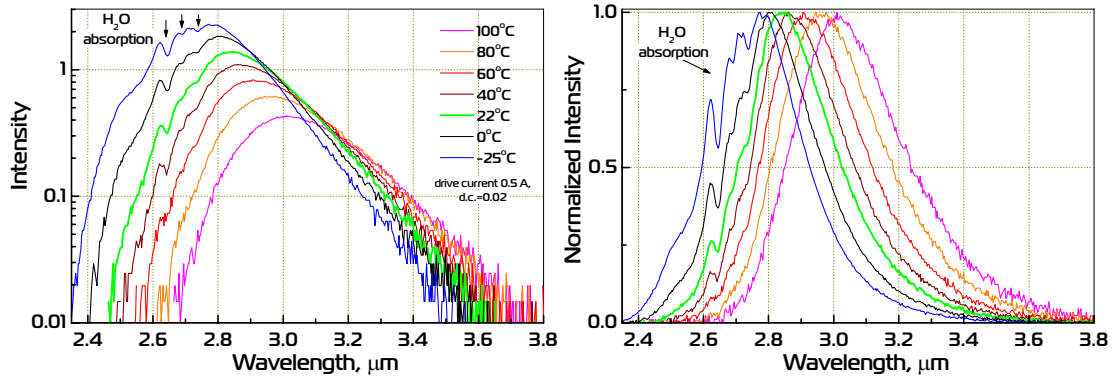


ООО «ИюффеЛЕД»
ioffeLED, Ltd

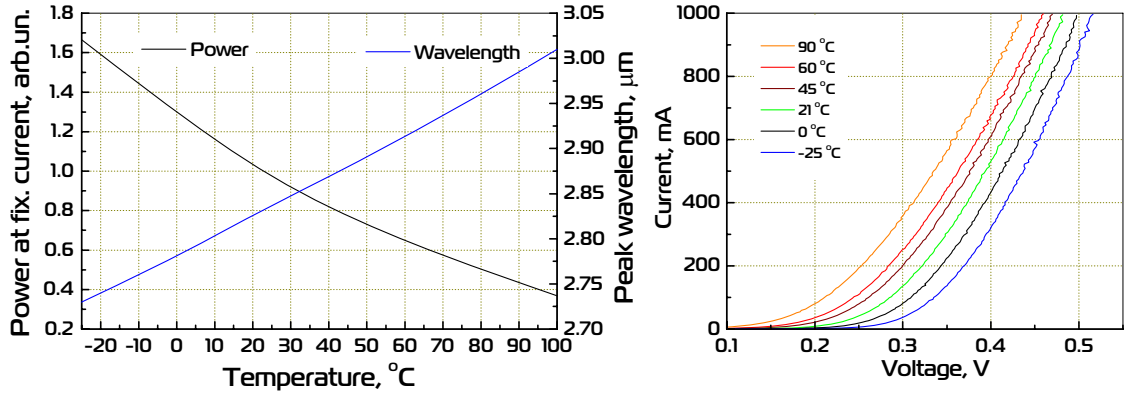
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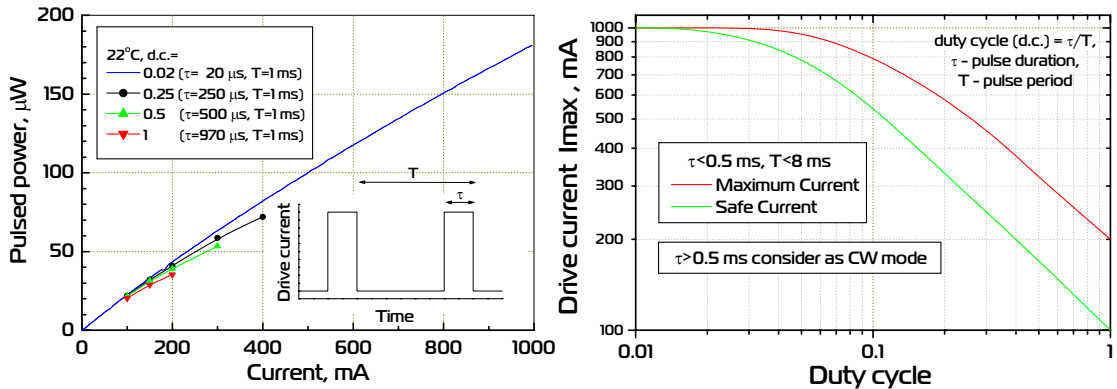
Emission spectra



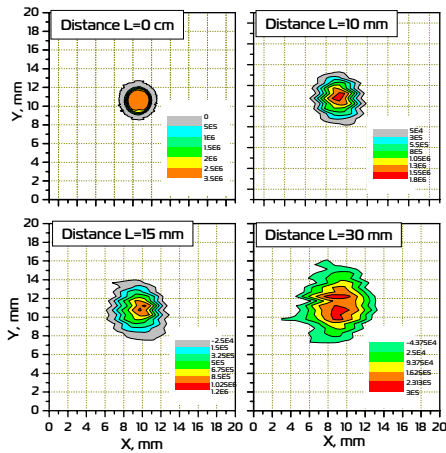
Power and peak wavelength vs. temperature; I - V curve



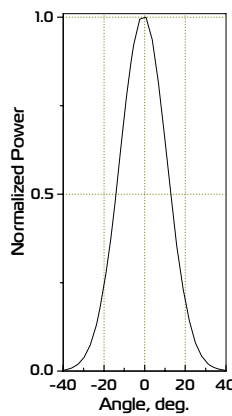
Output power and drive current vs operation conditions



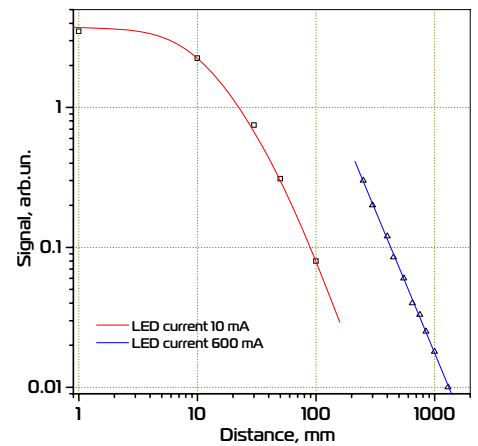
Radiation beam pattern in plane orthogonal to beam axis at several distances from LED



Angle distribution of output power



PD signal (PDxSr/Su) vs. distance from activated LED



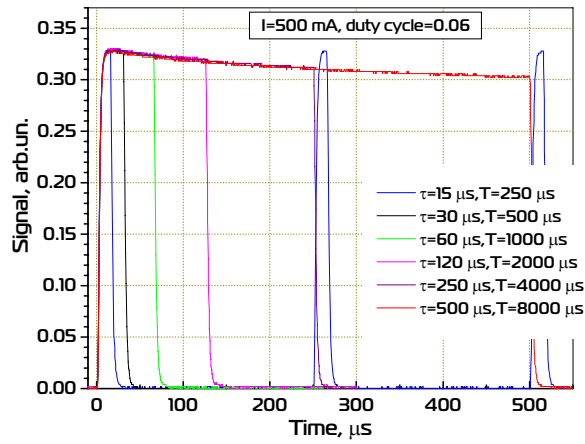
Far-field characterization



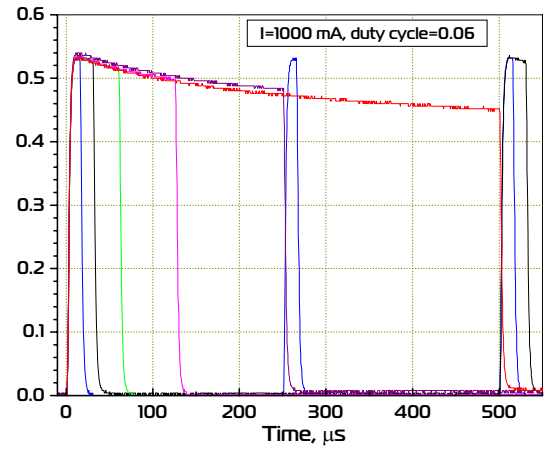
Time dependence of the output power for several values of d.c. and currents (LED attached to a heatsink at room temperature).

Pulse operation (d.c.=0.06)

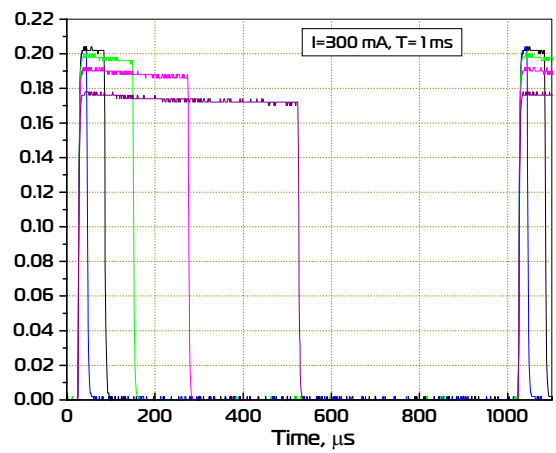
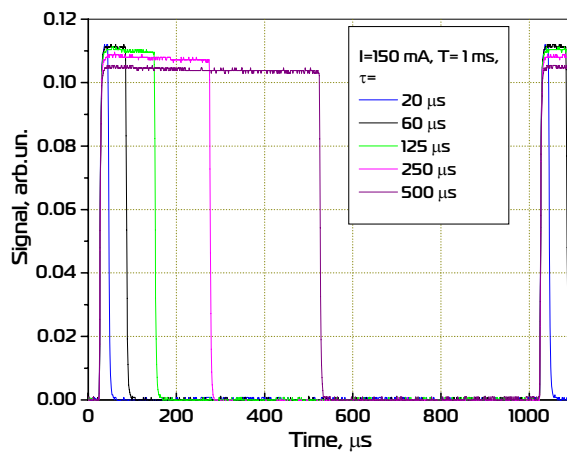
“Safe” operation mode



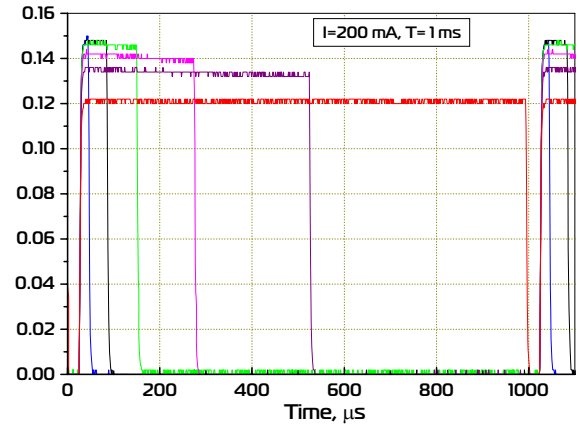
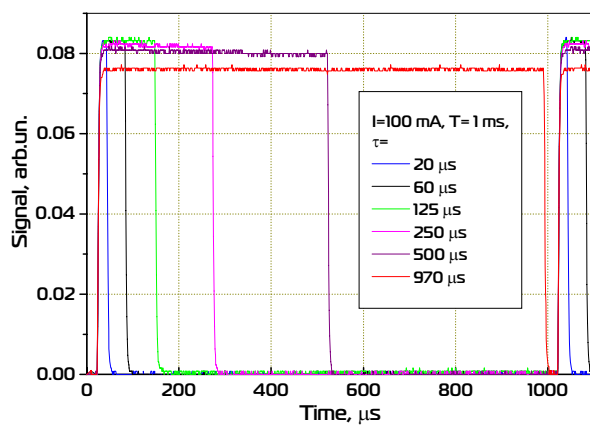
“Maximum current” operation mode



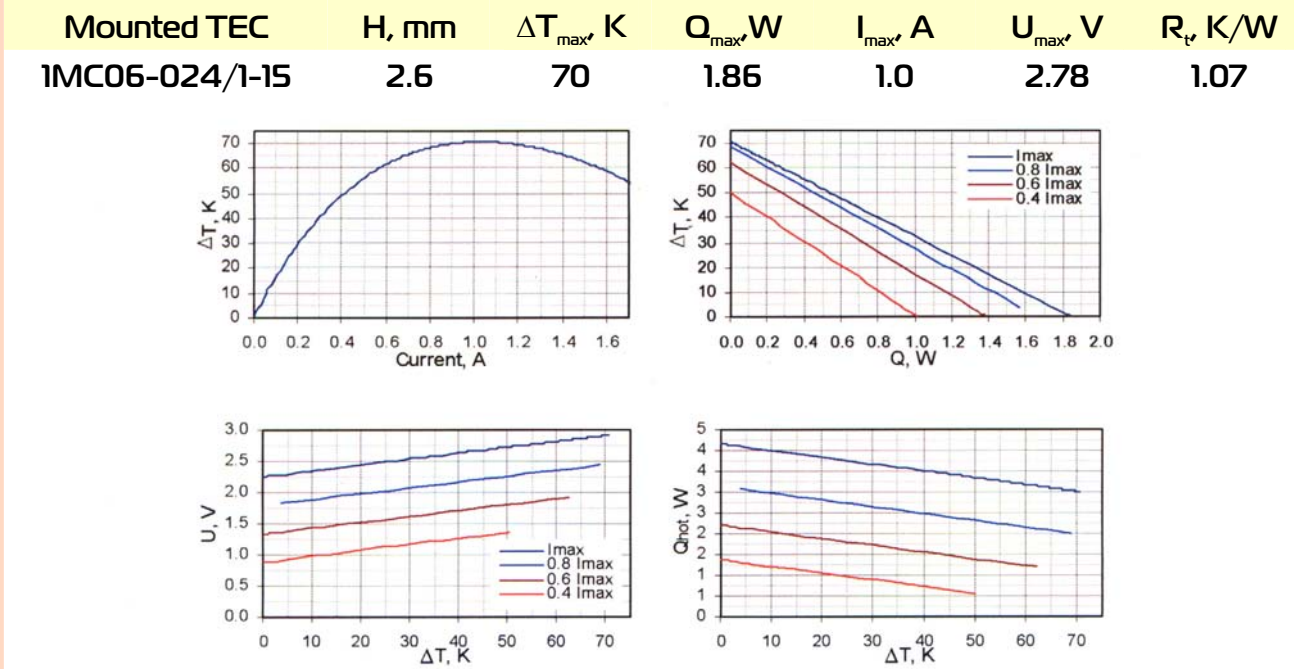
Quasi CW mode (d.c.=0.5)



CW mode (d.c.=1)

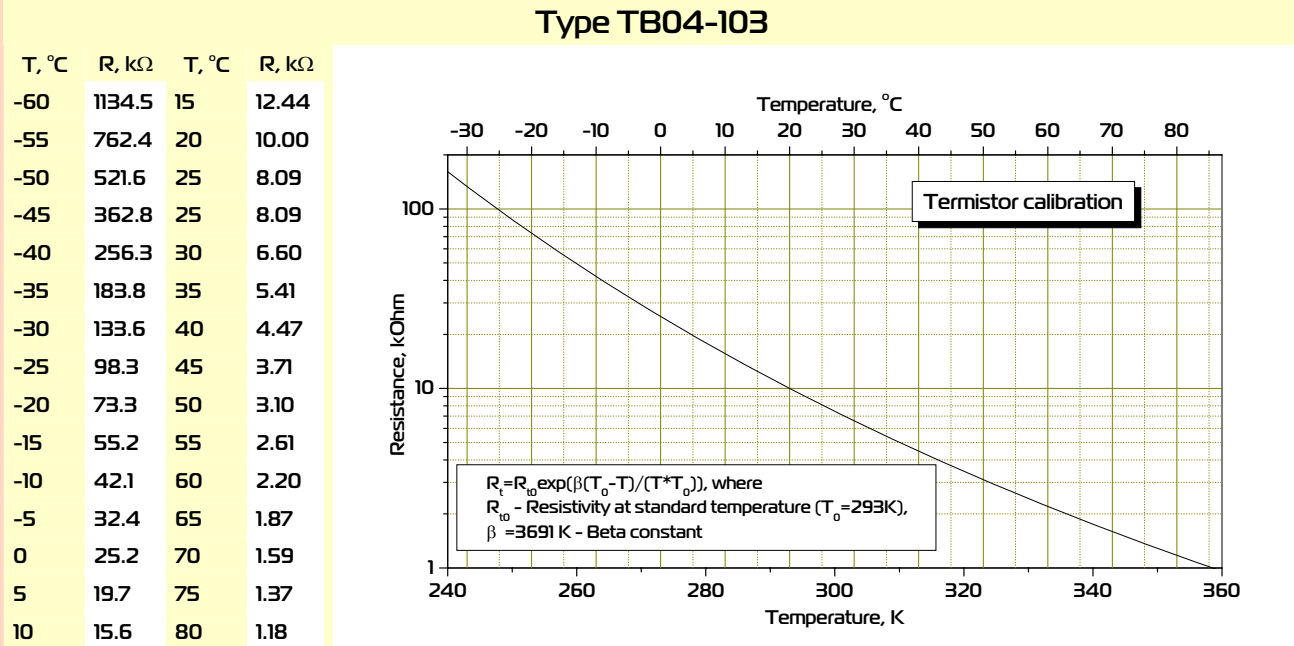


Thermoelectric cooling module datasheet



Data for $T_{hot}=300$ K, from www.tec-microsystems.com; www.rmtitd.ru

Thermistor specification



Possible TEC heatsink view

